

QMFF450R17XFF 1700V450A IGBT Module

Electrical Features

- Trench/Fieldstop IGBT
- Low VCE(sat)
- VCE(sat) with positive temperature coefficient
- $10 \ \mu \ s$ short circuit capability
- Fast&soft reverse recovery anti-parallel FWD
- Low inductance case



Typical Applications

- Motor Drives
- High Power Converters
- UPS System
- Servo Drives
- Wind Turbines

IGBT, Inverter

Maximu	m Rated Values						
Symbol	Item	Conditions			Rating		Unit
IGBT		·					
V _{CES}	Collector-emitter voltage	T _{vj} =25°C			1700		V
V _{GES}	Gate-emitter voltage	-			±20		V
Ic	Collector current,DC	T _C =100°C,T _{vj} =175°	°C		450		A
I _{CRM}	Repetitive peak collector current	t _p =1ms			900		Α
t _{SC}	Short circuit withstand time	V _{GE} =15V, V _{CC} =800	$V_{GE}=15V, V_{CC}=800V, T_{vj}\leq 150^{\circ}C$			10	
P _{tot}	Total power dissipation	T _C =25°C,T _{vj} =175°C	C		2500		W
Charact	eristics Values	·					
Symbol	Item	Conditions			Values		Unit
IGBT				Min.	Тур.	Max.	
I _{CES}	Collector-emitter cut-off current	V _{CE} =1700V,V _{GE} =0V,T _{vj} =25°C		-	-	3	mA
I _{GES}	Gate leakage current	$V_{CE}=0V, V_{GE}=20V, T_{vj}=25^{\circ}C$		-	-	400	nA
$V_{\text{GE(th)}}$	Gate-emitter threshold voltage	$I_{C}=12mA, V_{CE}=V_{GE}, T_{vj}=25^{\circ}C$		5.0	6.0	7.0	
	Collector-emitter saturation voltage	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	T _{vj} =25°C	-	2.4	-	V
V _{CEsat}			T _{vj} =125°C	-	-	-	V
			T _{vj} =150°C	-	-	-	
Cies	Input capacitance	- V _{CE} =25V,V _{GE} =0V - f=1MHz,T _{vj} =25°C - V _{CC} =800V, I _C =450A, V _{GE} =15V		-	43.8	-	
Coes	Output capacitance				1.47		nF
Cres	Reverse transfer capacitance			-	1.32	-	
Q _G	Gate charge			-	5.1	-	μC
Rg	Internal gate resistance	T _{vj} =25°C			1.7		Ω



				-	-		
Erec	Reverse recovered energy		T _{vj} =125°C T _{vj} =150°C	-	-	-	mJ
F			$T_{vj}=25^{\circ}C$	-	25.5	-	-
		-	$T_{vj}=150^{\circ}C$	-	-	-	
Qr	Recovered charge		$T_{vj}=125^{\circ}C$	-	-	-	μC
t _{rr}		V_{GE} =-15V	T _{vj} =25°C	-	52	-	_
		$-I_F=450A$	T _{vj} =150°C	-	-	-	
	Reverse recovery time	V _R =900V	T _{vj} =125°C	-	-	-	ns
			T _{vj} =25°C	-	677	-	-
		_	T _{vj} =150°C	-	-	-	
I _{RM}	Peak reverse recovery current		T _{vj} =125°C	-	-	-	A
_			$T_{vj}=25^{\circ}C$	-	191.5	-	-
			T _{vj} =150°C	-	-	-	
\mathbf{V}_{F}	Continuous forward voltage	$V_{\text{GE}}=0V$	T _{vj} =125°C	-	-	-	V
		I _F =450A	T _{vj} =25°C	-	2.23	-	
Characte	eristic Values			1	1		1
I _{FRM}	Repetitive peak forward current	t _p =1ms			900		Α
I _F	Forward current,DC				450		Α
V _{RRM}	Repetitive peak reverse voltage	T _{vj} =25°C			17	00	V
Symbol	Item	Conditions			Rat	ing	Unit
	Inverter m Rated Values						
T_{vjop}	Temperature under switching conditions			-40		150	°C
R_{thCH}	Thermalresistance, case to heatsink	per IGBT/ λgreas	$e=1W/(m\cdot K)$	-	0.029	-	K/W
R_{thJC}	Thermal resistance, junction to case	per IGBT		-	-	0.06	K/W
			T _{vj} =150°C	-	-	-	
E_{off}	Turn-off energy (per pulse)		T _{vj} =125°C	-	-	-	_
_			T _{vj} =25°C	-	94.0	-	
		_	T _{vj} =150°C	-	-	-	mJ
Eon	Turn-on energy (per pulse)		T _{vj} =125°C	-	-	-	
			T _{vj} =25°C	-	159.7	-	4
		Inductive load	T _{vj} =150°C	-	-	-	
t_{f}	Fall time	$R_{G(off)}=2.4 \Omega$,	T _{vj} =125°C	-	-	-	4
		$R_{G(on)}=2.4 \Omega$,	T _{vj} =25°C	-	361	-	
		$V_{GE}=\pm 15V$,	T _{vj} =150°C	-	-	-	
$t_{d(off)}$	Turn-off delay time	Ic=450A,	T _{vj} =125°C	-	-	-	
		V _{CC} =900V,	T _{vj} =25°C	-	579	-	115
			T _{vj} =150°C	-	-	-	ns
t _r	Rise time		T _{vj} =125°C	-	-	-	
_			T _{vj} =25°C	-	216	-	
			T _{vj} =150°C	-	-	-	
$t_{d(on)}$	Turn-on delay time		$T_{vj}=125^{\circ}C$	-	-	-	
			T _{vj} =25°C				



R _{thJC}	Thermal resistance, junction to case	per diode	-	-	0.1	K/W
R _{thCH}	Thermalresistance, case to heatsink	per diode/ λ grease=1W/(m·K)	-	0.05	-	K/W
T _{vjop}	Temperature under switching conditions		-40		150	°C

Module

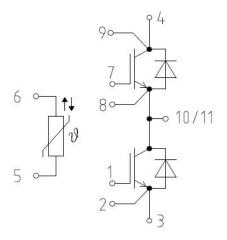
Symbol	Item	Conditions	Rating			Unit
V _{ISOL}	Isolation voltage	Terminals to baseplate, RMS,f=50Hz,t=1min	2500			V
-	Material of module baseplate	-	Cu		-	
-	Internal isolation	Basic insulation(class 1, IEC 61140)	Al ₂ O ₃			-
T _{stg}	Storage temperature	-	-40~125		5	°C
Symbol	Item	Conditions	Values			Unit
			Min.	Тур.	Max.	
М	Mounting torque for module mounting	Screw M6	3.0	-	5.0	Nm
	Terminal connection torque	Screw M6	2.5	-	5.0	Nm
ds	Creepage distance	Terminal to terminal	-	13	-	
		Terminal to base plate	-	14.5	-	mm
da	Clearance	Terminal to terminal	-	10	-	
		Terminal to base plate	-	12.5	-	mm
m	Weight	-	-	340	-	g

NTC Thermistor Characteristics

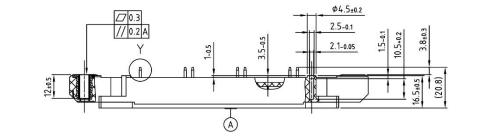
Symbol	Item	Conditions	Values			Unit
		Conditions	Min.	Тур.	Max.	
R ₂₅	Rated resistance	$T_{\rm C}=25^{\circ}{\rm C}$	-	5	-	kΩ
$\Delta R/R$	Deviation of resistance	$T_{C}=100^{\circ}C, R_{100}=493\Omega$	-5	-	5	%
P ₂₅	Power dissipation	$T_{\rm C}=25^{\circ}{\rm C}$	-	-	20	mW
B _{25/50}	B-constant	$R_2 = R_{25} exp[B_{25/50}(1/T_2 - 1/(298.15K))]$	-	3375	-	
B _{25/80}	B-constant	$R_2 = R_{25} exp[B_{25/80}(1/T_2 - 1/(298.15K))]$	-	3411	-	K
B _{25/100}	B-constant	$R_2 = R_{25} exp[B_{25/100}(1/T_2 - 1/(298.15K))]$	-	3433	-	

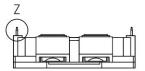


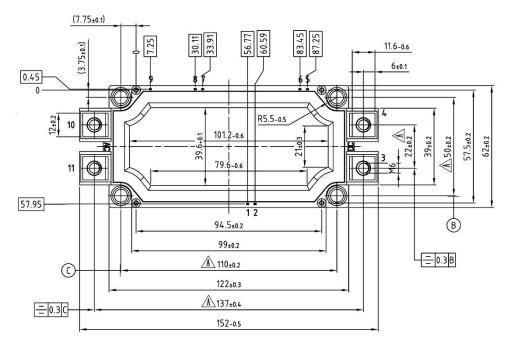
Circuit diagram headline

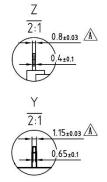


Package outlines (Unit: mm)











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